КАМАҮА ОНМ ——		
	No.: Date:	FCCR-K-HTS-0001 2024. 12. 24
Data	a sheet	
Title: CHIP FUSE; RECT		
Style: FCCR10,16		<u> </u>
Halogen anNote:• Stock conditionsTemperature:+5°C ~ +35Relative humidity:25% ~The period of guarantee:• Product specification coare subject to change and	75% Within 2 year from shipn Solderability shall be sa ontained in this data sh at any time without noti ons or a Purchasing Sp	eet neet ce becification for any quality
TE.	送屋電 KAMAYA	模株式會社 ELECTRIC CO., LTI Hokkaido Research Cente Approval by: T. Sannomiya

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### 1. Scope

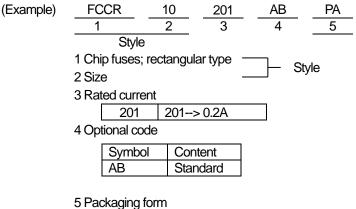
1.1 This data sheet covers the detail requirements for chip fuses; rectangular type, style of FCCR10,16.

1.2 Applicable documents

UL248–1–2000 Low–Voltage Fuses–Part1: General Requirements UL248–14–2000 Low–Voltage Fuses–Part14: Supplemental Fuses CSA C22.2 No.248.1–2000 Low–Voltage Fuses–Part1: General Requirements CSA C22.2 No.248.14–2000 Low–Voltage Fuses–Part14: Supplemental Fuses IEC60127–1 Miniature fuses–part 1: Definitions for miniature fuses and general requirements for miniature fuse–links IEC60127–4 Miniature fuses–Part4: Universal modular fuse–links (UMF)

## 2. Classification

Type designation shall be the following form.



Press pocket taping
Paper taping

3. Safety standard approval

• UL248-1 and UL248-14

• CSA C22.2, No. 248.1–00 and CSA C22.2, No. 248.14–00

The file number to be designated by UL and C–UL shall be as follows: E176847

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### 4. Rating

4.1 The ratings shall be in accordance with Table-1.

	Table-1							
	Rated current		Internal Rated		Breaking	Time / current characteristic		
Style	Symbol	(A)	Marking symbol	resistance value (mΩ max.)	voltage (V)	capacity (A)	Current	Pre-arcing time
	151	0.15		1850	(•)	(* 9		
	201	0.2	Z	1250				
500040	251	0.25	C	880	<b>D</b> 004	05	0000/	<b>F</b>
FCCR10	321	0.315	D	600	DC24	35	200%	5 s max.
	401	0.4	E	400				
	501	0.5	F	300				
	151	0.15	OB	2300				
	201	0.2	ZB	1350				
	251	0.25	CB	1000				
	321	0.315	DB	600				
	401	0.4	EB	450				
	501	0.5	FB	300				
	631	0.63	IB	220				
FCCR16	751	0.75	AB	190	DC50	50	200%	5 s max.
	801	0.8	KB	165				
	102	1.0	LB	130				
	132	1.25	MB	110				
	152	1.5	HB	90				
	162	1.6	NB	75				
	202	2.0	SB	65				
	252	2.5	TB	40				

4.2 Working temperature range: -55 to +125(°C)

## 5. Packaging form

The standard packaging form shall be in accordance with Table-2.

	Table-2							
Symbol	Packaging form		Standard packaging quantity / units	Application				
PA	Press pocket taping (paper taping)	8mm width, 2mm pitches	10,000 pcs.	FCCR10				
TP	Paper taping	8mm width, 4mm pitches	5,000 pcs.	FCCR16				

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#### 6. Dimensions

6.1 The resistor shall be of the design and physical dimensions in accordance with Figure-1 and Table-3.

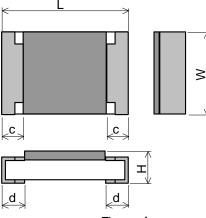


Figure-1 Table-3

Table-3					Unit:mm
Style	L	W	Н	С	d
FCCR10	1.0±0.05	0.5±0.05	0.4±0.05	0.2±0.1	0.25±0.10
FCCR16	1.6±0.1	0.8 +0.15	0.45±0.10	0.3±0.15	0.3 <u>+</u> 0.1

#### 6.2 Net weight (Reference)

Style	Net weight(mg)
FCCR10	0.8
FCCR16	2

### 7. Marking

The Marking symbol of Sub- clause 4.1 shall be marked on over coat side.

#### (Example)

_						
	Style	Optional code	Marking symbol	Content		
	FCCR10	AB	Z	FCCR10 201 AB		
	FCCR16	AB	EB	FCCR16 401 AB		

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### 8. Performance

8.1 Unless otherwise specified, the standard range of atmospheric conditions for tests is as follows; Ambient temperature: 5 °C to 35 °C, Relative humidity: 45 % to 85 %, Air presser: 86 kPa to 106 kPa If there is any doubt the results, measurements shall be made within the following:

Ambient temperature: 20 °C  $\pm$  2 °C, Relative humidity: 60 % to 70 %, Air presser: 86 kPa to 106 kPa 8.2 The performance shall be satisfied in Table–4.

		Table-4(1)			
No.	Test items	Condition of test	Perfo	rmance re	quirements
1	Temperature rise	The fuse shall be mounted on the test substrate as	75 °C max.		
		shown in Figure–2.			
		Measurement temp.: 10 °C to 30 °C			
		Test current: Rated current			
		The temperature at the hottest point on the surface of			
		the fuse shall be measured after temperature			
	-	equilibrium has been attained.			
2	Current carrying capacity	The fuse shall be mounted on the test substrate as	Without o	pening	
		shown in Figure–2.			
		Test current: 110 % of Rated current			
		Test temp.: 70 °C $\pm$ 2 °C			
		Test period: 1h			T
3	Time / current characteristic	The fuse shall be mounted on the test substrate as	Optional code	Current	Pre-arcing
		shown in Figure-2.	AB	200%	time 5 s max.
		Test current shall be applied for continuously.	AD	200%	osmax.
4	Terminal bond strength of	JIS C 60068-2-21 Ue1	Change of	of internal r	esistance:
	the face plating	The fuse shall be mounted on the test substrate as	±10%		
		shown in Figure–2.			f mechanical
		Bending value: 3 mm (Among the fulcrums: 90 mm)	damage.		
		Duration: $10 \text{ s} \pm 1 \text{ s}$	_		
5	Resistance to soldering	Test by a piece.	Change of	of internal r	esistance:
	heat	Temp. of solder bath: 260 °C $\pm$ 5 °C	±10%		
		Immersion time: $10 \text{ s} \pm 1 \text{ s}$	No evid	dence of	appearance
		After immersion into solder, leaving the room temp.			
		for 1h or more, and then measure the internal			
		resistance.			
		Reflow soldering			
		Pre-heating: 150 °C ~ 180 °C, 120 s max.			
		Peak: 260 °C $\pm$ 5 °C, 10 s max.			
		Refrow cycle: 2 times			
		After immersion into solder, leaving the room temp.			
		for 1h or more, and then measure the internal			
		resistance.			
6	Solderability	JIS C 60068-2-58			al immersed shall
		Test by a piece			ered with a new
		Flux: Rosin–Methanol	coating of	soider.	
		Temp. of solder: bath: 235 $^{\circ}C \pm 5 ^{\circ}C$			
		Immersion time: $2 s \pm 0.5 s$			

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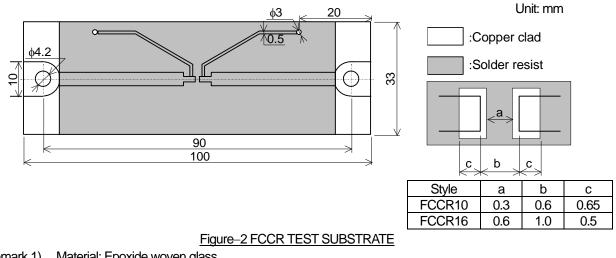
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	Table-4(2)					
No.	Test items	Condition of test Performance requirement				
7	Rapid change temperature	JIS C 60068-2-14 Na	Change of internal resistance:			
		The fuse shall be mounted on the test substrate as	±10%			
		shown in Figure–2.	No evidence of appearance			
		Upper temperature: +125 °C	damage			
		Lower temperature: -55 °C				
		Duration of exposure at each temperature: 30 min.				
		Number of cycles: 5 cycles				
8	Endurance test	The fuse shall be mounted on the test substrate as	The voltage drop across the fuse			
		shown in Figure–2.	after the test shall not have			
		Test condition: Nominal ambient temp. and Relative	increased by more than 10 % of			
	humidity.		the value measured before test.			
		Test potential:				
		1. Cycle of 1 h "ON" and 15 min. "OFF" at 1.05 times				
		rated current for 100 cycles.				
		2. After above the test, 1.25 times rated current for				
		1h.				

#### 9. Test substrate



Remark 1). Material: Epoxide woven glass Thickness: 1. 6mm Thickness of copper clad: 0. 035mm

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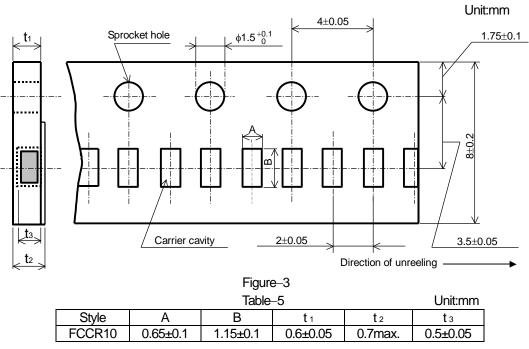
## 10. Taping

10.1 Applicable documents JIS C 0806–3: 2014, EIAJ ET–7200C: 2010

10.2 Taping dimensions

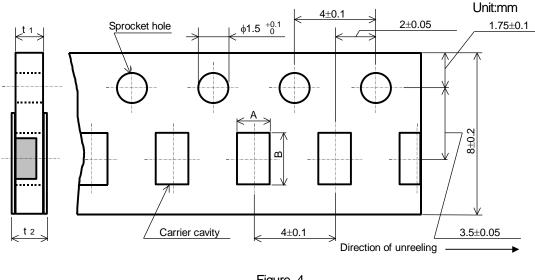
10.2.1 Press pocket taping(8mm width, 2mm pitches)

Taping dimensions shall be in accordance with Figure-3 and Table-5.



### 10.2.2 Paper taping (8mm width, 4mm pitches)

Taping dimensions shall be in accordance with Figure-4 and Table-6.



		-igure-4			
Table–6 Unit:					m
Style	А	В	t 1	t 2	
FCCR16	1.15±0.15	1.9±0.2	0.6±0.1	0.8 max.	

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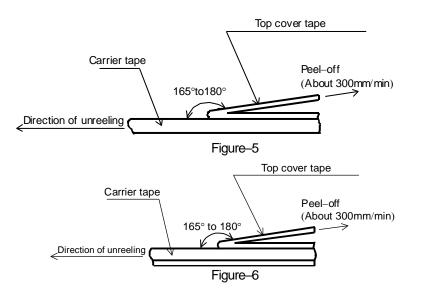
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- 1). The cover tapes shall not cover the sprocket holes.
- 2). Tapes in adjacent layers shall not stick together in the packing.
- 3). Components shall not stick to the carrier tape or to the cover tape.
- 4). Pitch tolerance over any 10 pitches ±0.2mm.
- 5). The peel strength of the top cover tape shall be with in 0.1N to 0.5N on the test method as shown in the following FCCR10:Figure-5,FCCR16: Figure-6.
- 6). When the tape is bent with the minimum radius for 25 mm, the tape shall not be damaged and the components shall maintain their position and orientation in the tape.
- 7). In no case shall there be two or more consecutive components missing.
  - The maximum number of missing components shall be one or 0.1%, whichever is greater.
- 8). The fuses shall be faced to upward at the over coating side in the carrier cavity.



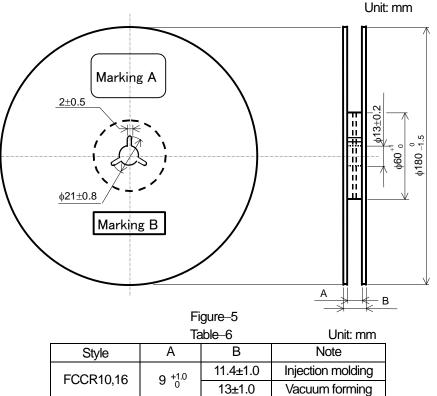
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#### 10.3 Reel dimension

Reel dimensions shall be in accordance with the following Figure–5 and Table–6.

Plastic reel (Based on EIAJ ET-7200C)



Note: Marking label shall be marked on a place of Marking A or two place of marking A and B.

10.4 Leader and trailer tape.

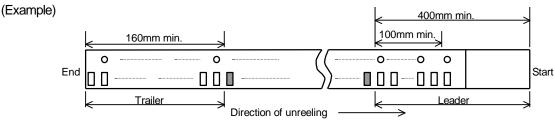


Figure-8

### 11. Marking on package

The label of a minimum package shall be legibly marked with follows.

### 11.1 Marking A

(1) Classification (Style, Rated current, Optional code, Packaging form) (2) Quantity (3) Lot number

(5) Manufacturer's name or trade mark (6) UL and /or C–UL recognized component mark (7) Others

### 11.2 Marking B (KAMAYA Control label)

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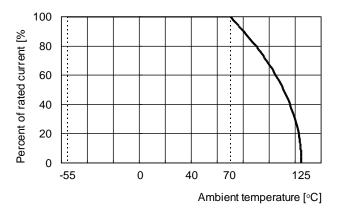
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- 12. Recommended Derating for Rated Current
  - •Nominal Derating

Option Code AB: Nominal Derating  $\leq$  75% of Rated Current

•Temperature Derating

Please refer to the following graph regarding the current derating value for ambient temperature.



Ex.) • If Optional code: AB (Rated Current:0.5A) is used under ambient temperature 70°C Kamaya recommends, less than the current value derated as below, Rated Current: 0.5A × (Nominal Derating : 75% × Temperature Derating : 100%) =0.375A

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